



RI.
SE

European Outlook - In the age of BragaWatts

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4th December, 2025



RISE ICE Data Center

A full-scale research datacenter and test environment with the objective to increase knowledge and strengthen the global AI & Data Center ecosystems

- 40+ projects, from the ground to the cloud
- 30+ employees
- 4+ MEUR turnover
- Established 2016
- 100+ project partners



**EARTO Innovation
Awards 2022**
Holistic Cooling

Current Official Partners in the Partner Program

Premium partners:



Collaborators:



Academic:



Agenda

01

Background to 'BragaWatts'

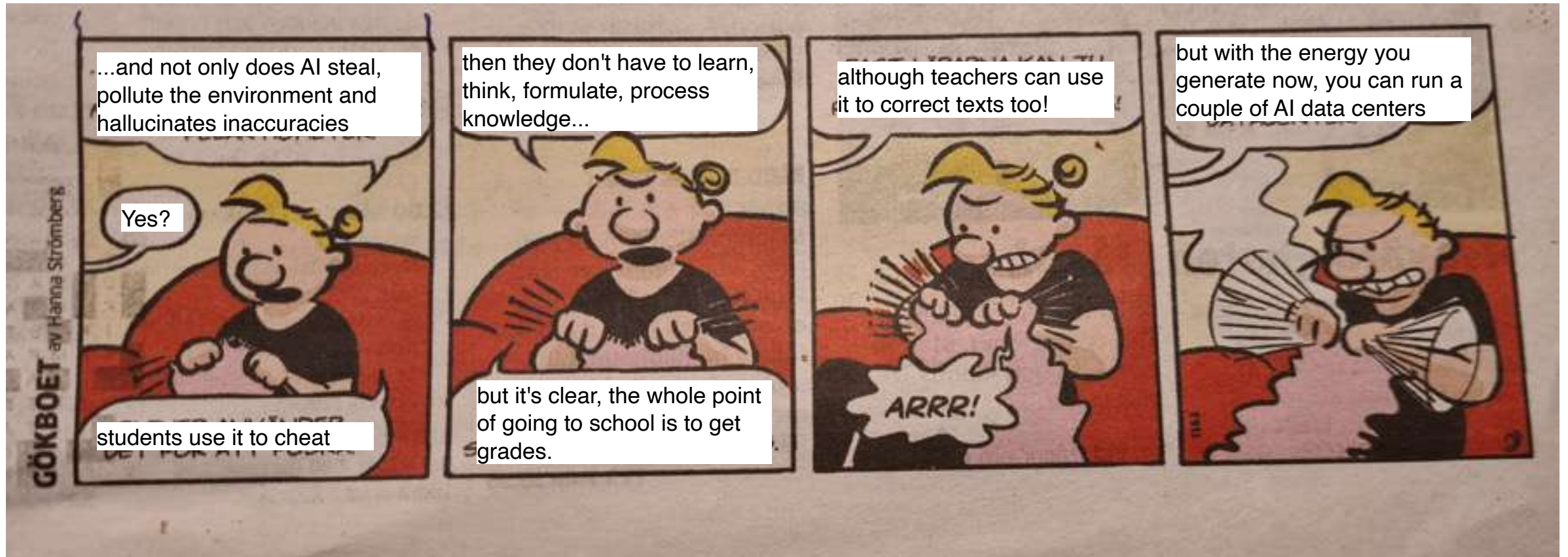
02

EUDCA ongoing work and future outlook

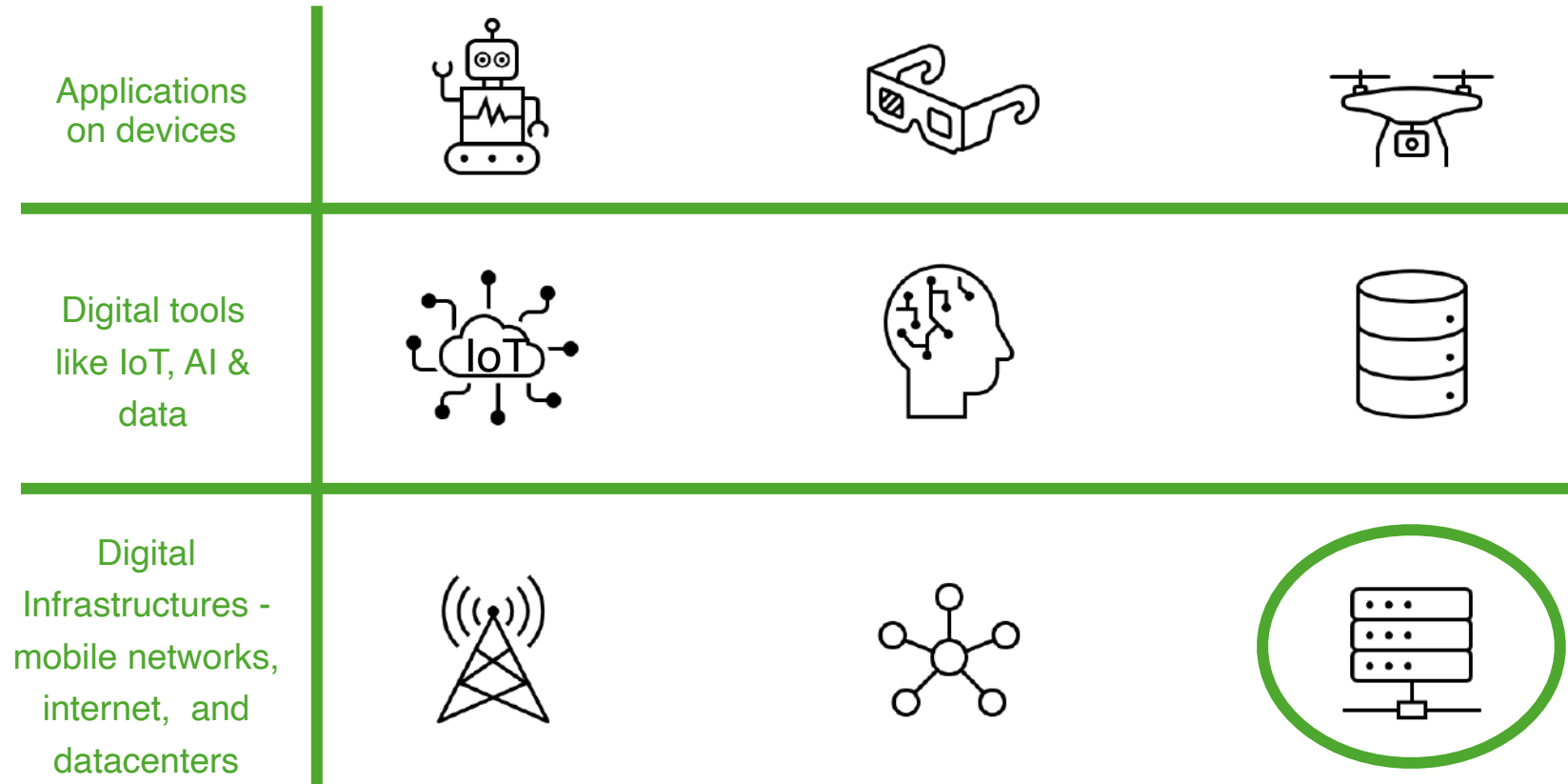
03

Nordic role?

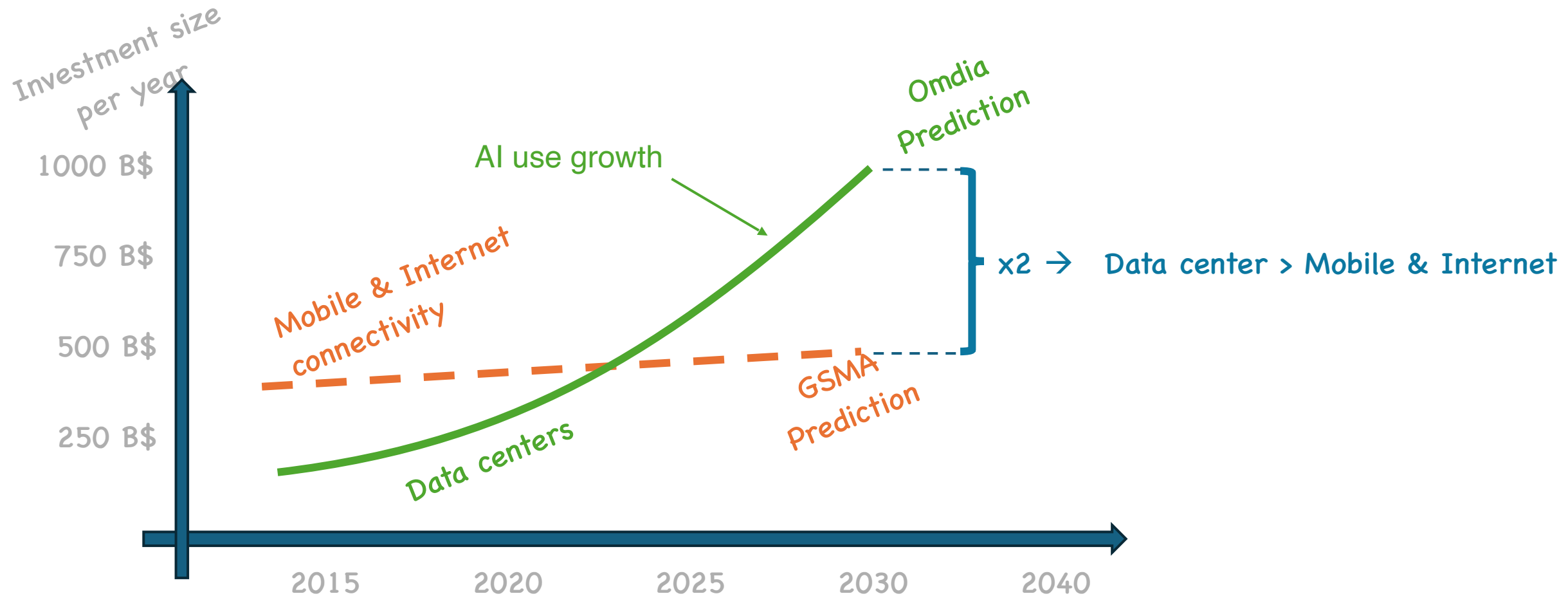
Comic strip about energy & AI data centers



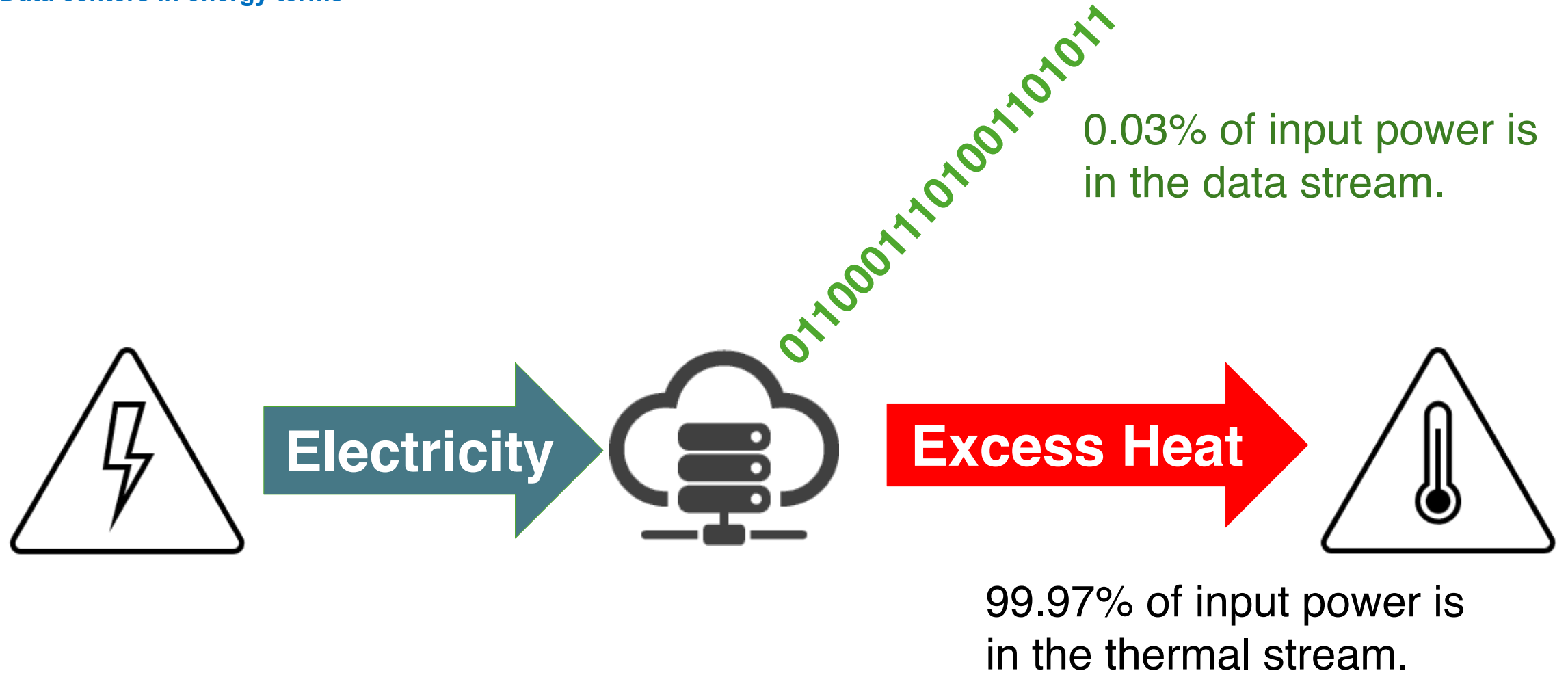
Digital infrastructure – including data centers – is the foundation for AI



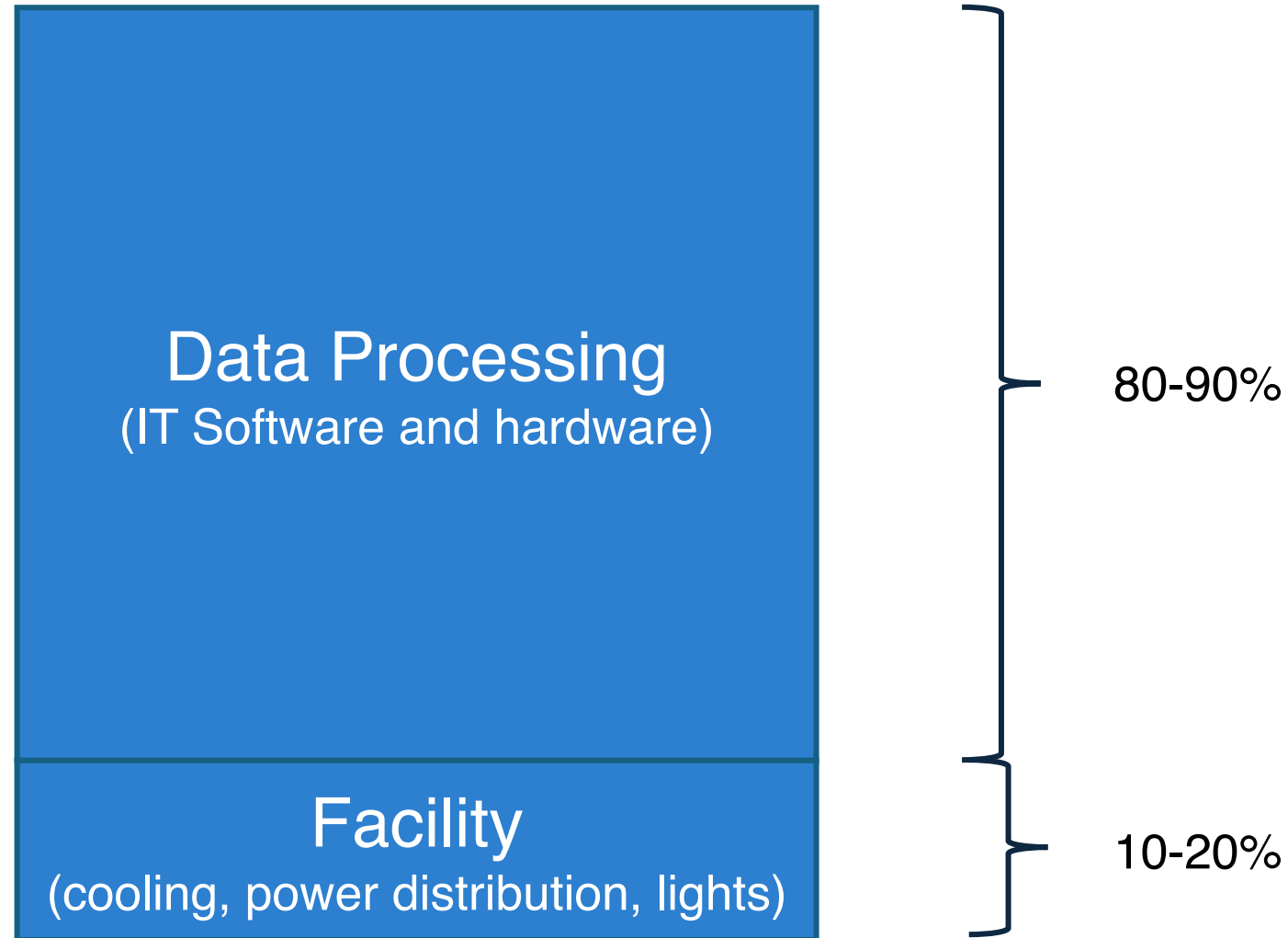
Data centers vs connectivity investment sizes



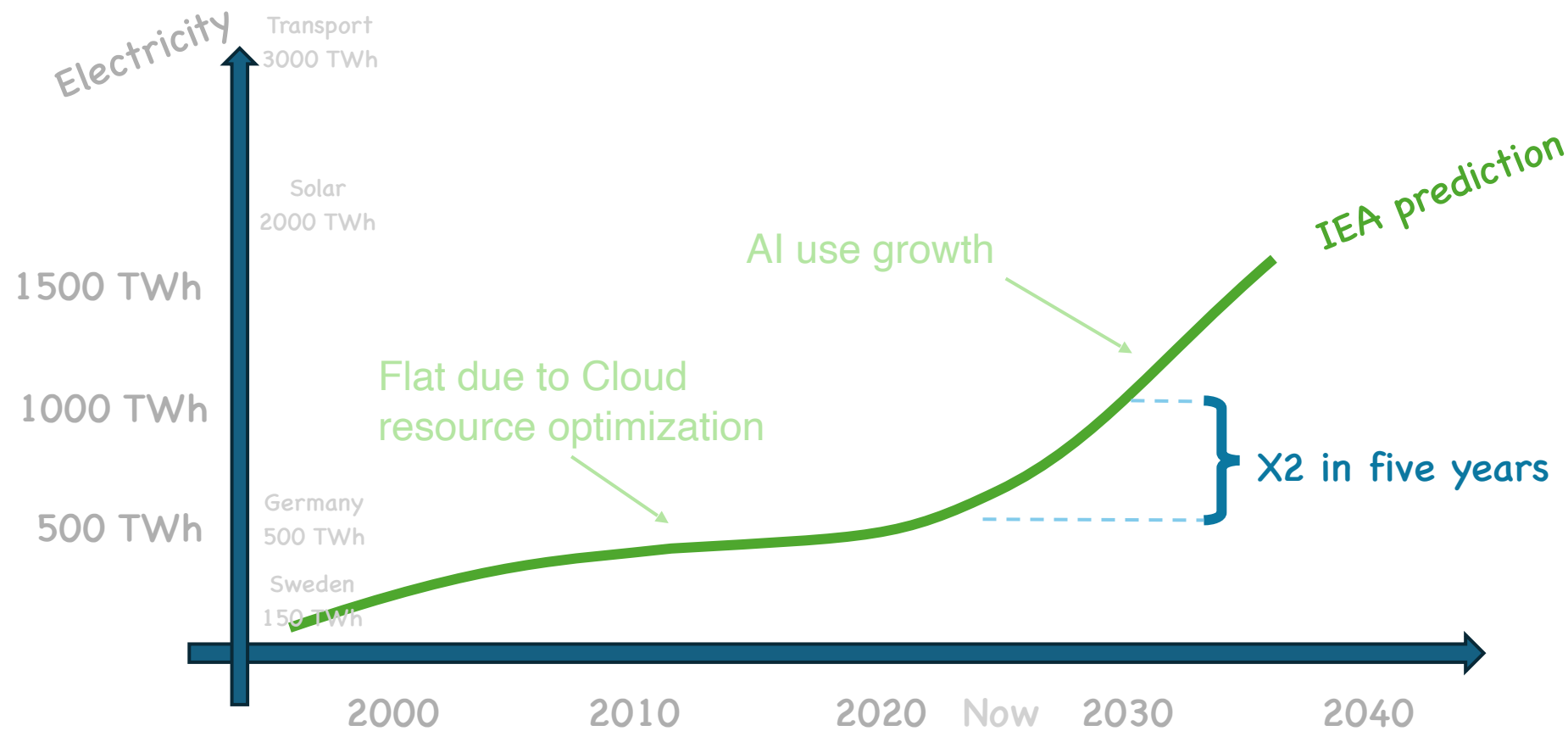
Data centers in energy terms



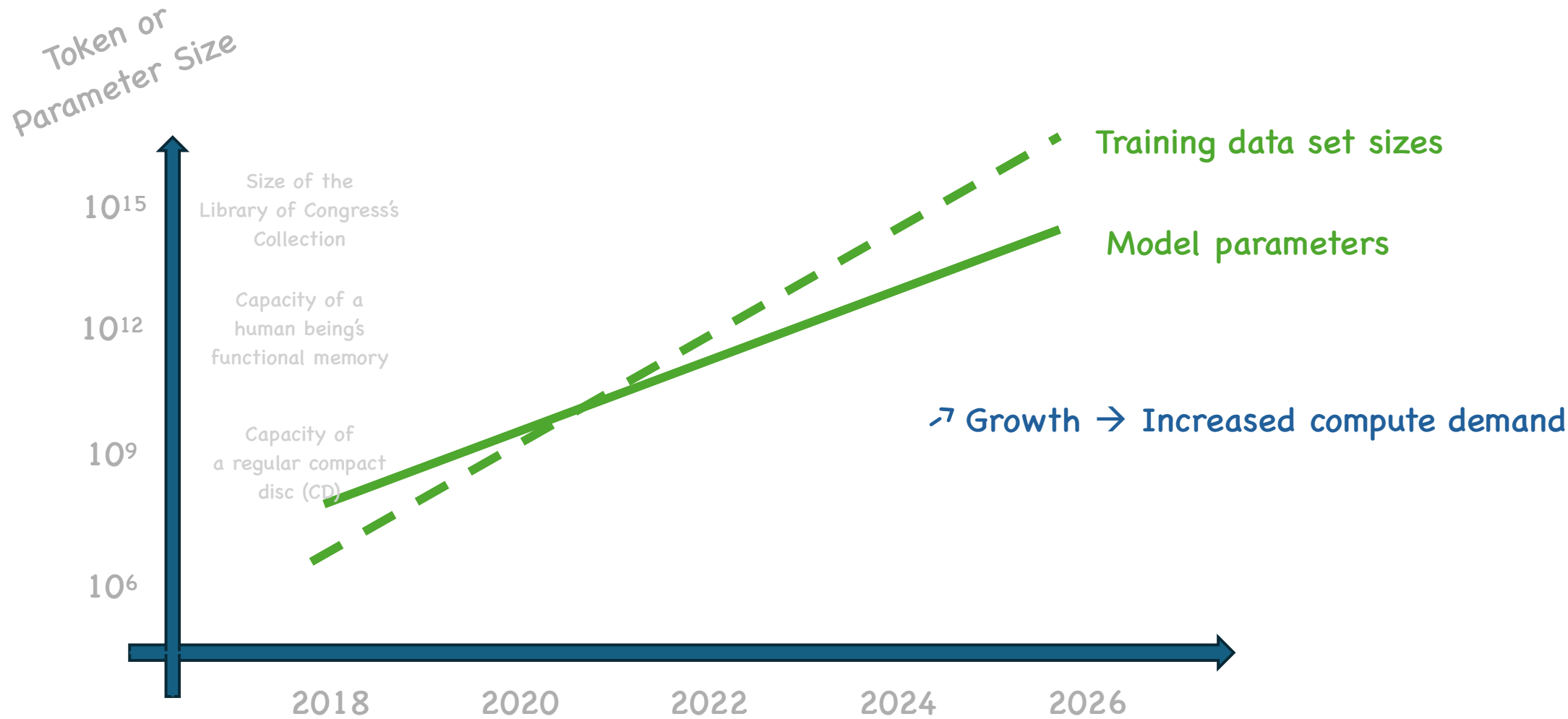
Where do the energy go? 99,97% becomes heat (illustration)



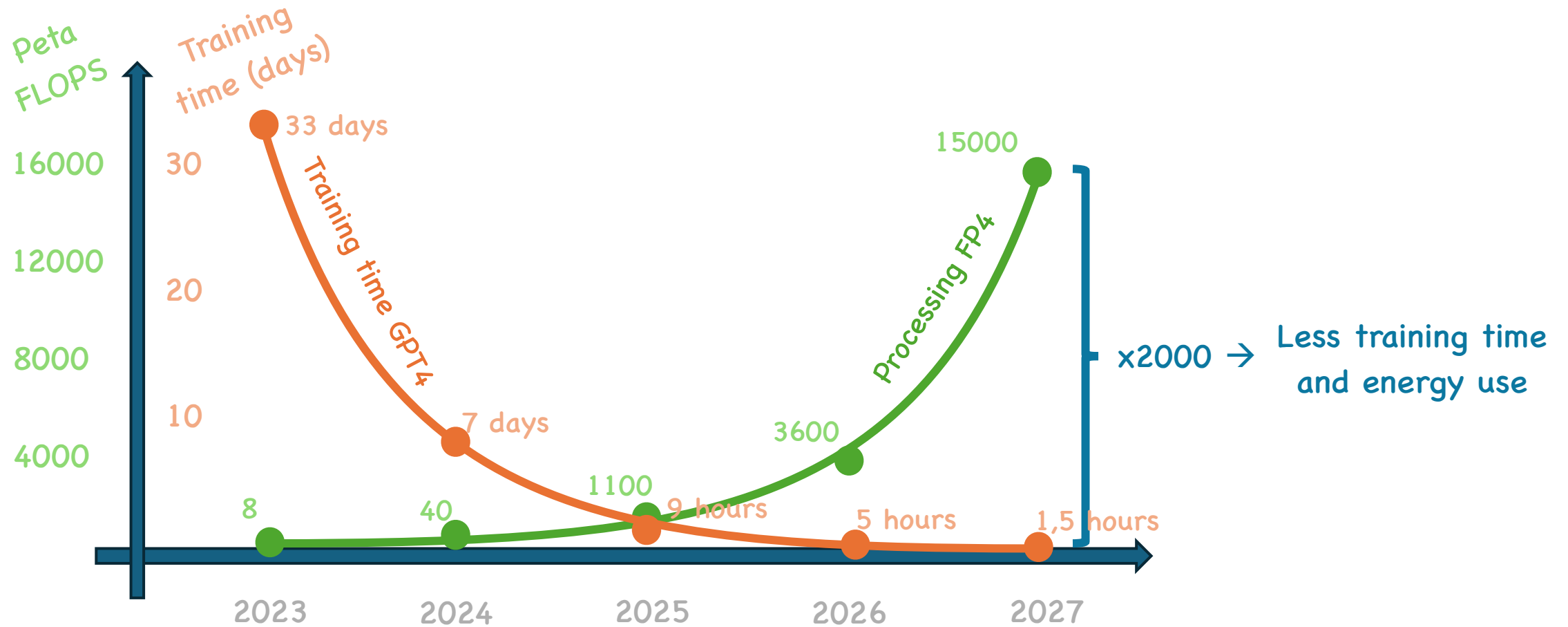
Global electricity demand in data centers



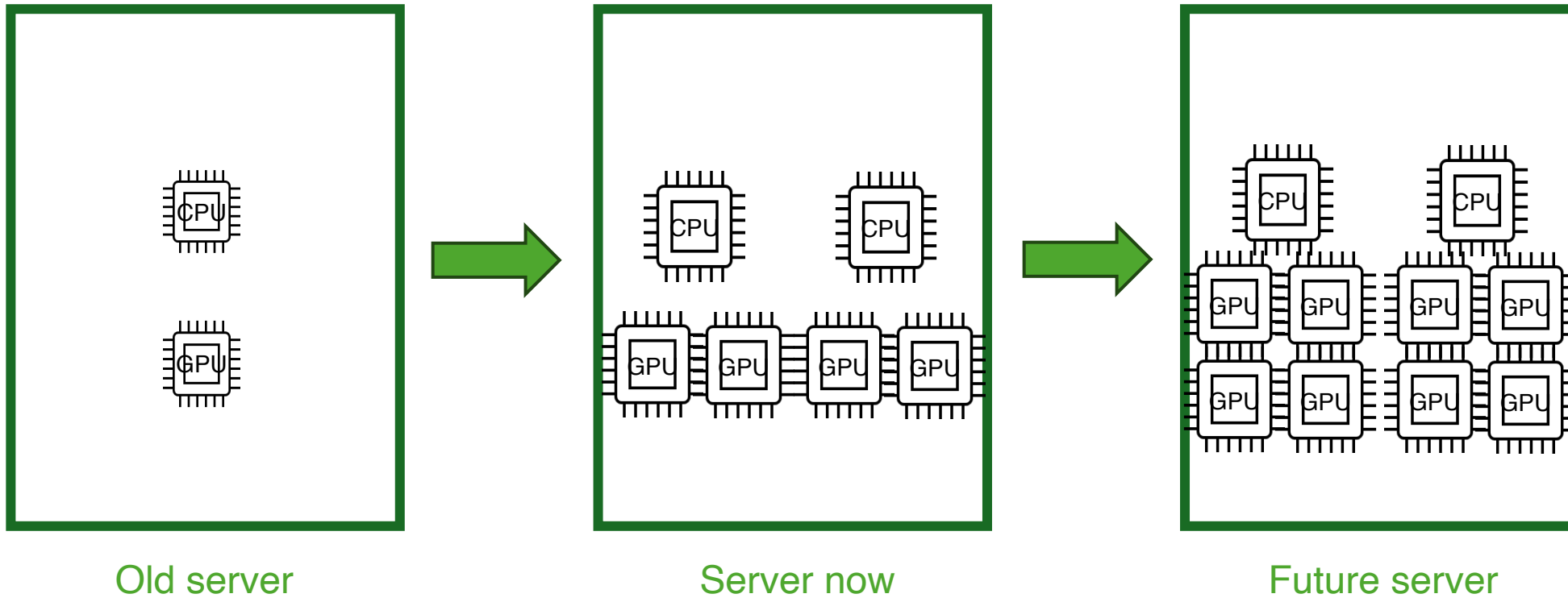
Size of AI models and training data used



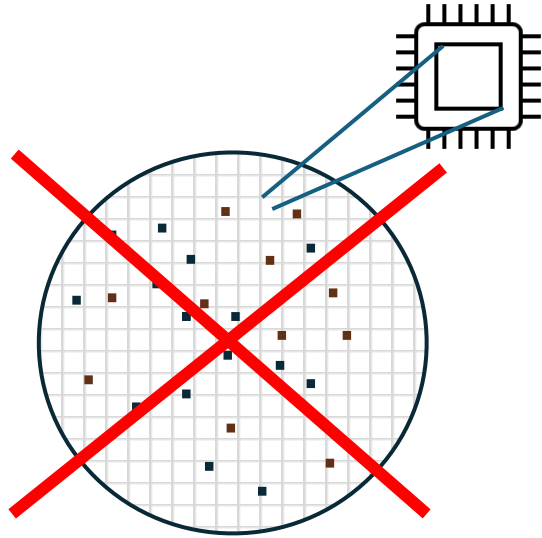
Development of compute performance in Nvidia GPUs



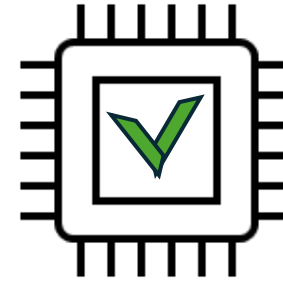
Increased density in rack & server design



Chip design is limited by the physics

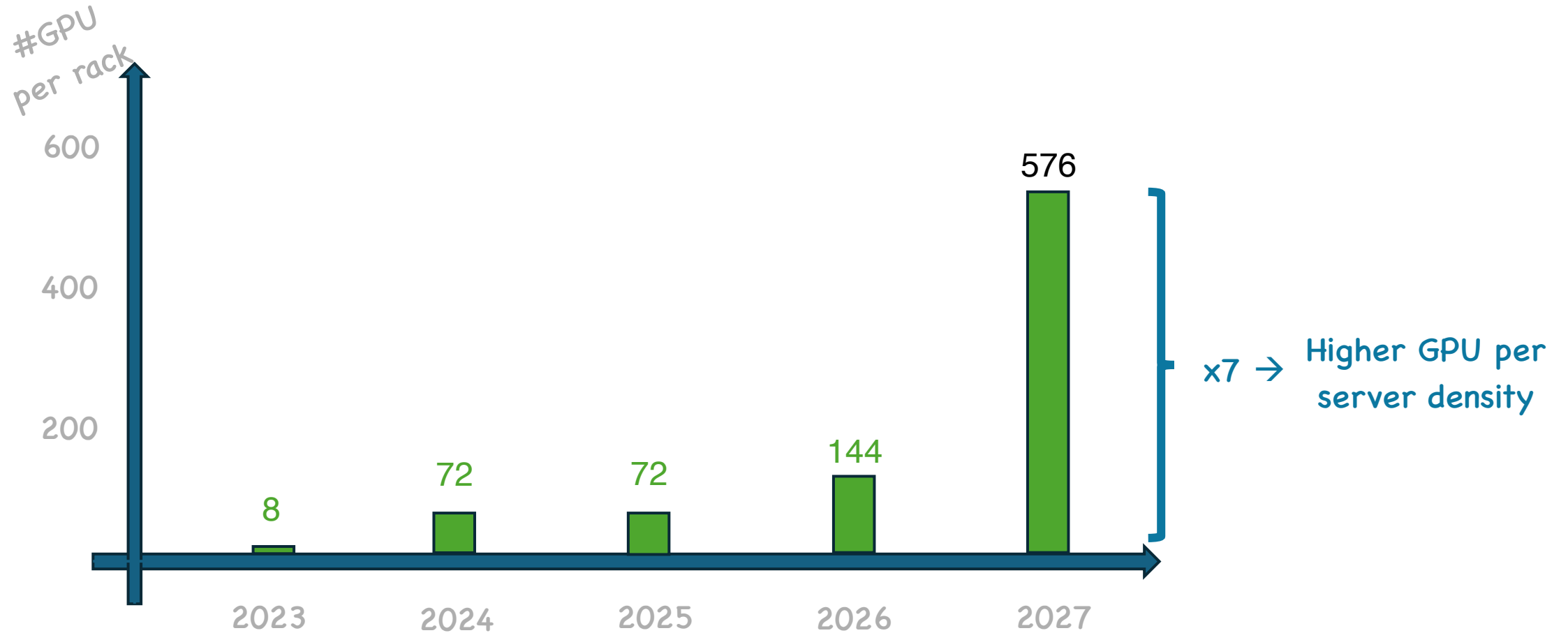


Utopia: One super chip
+ Could enable fast RAM/COM
- Faulty parts of the silicon
- Difficult to power and cool
- Difficult to package

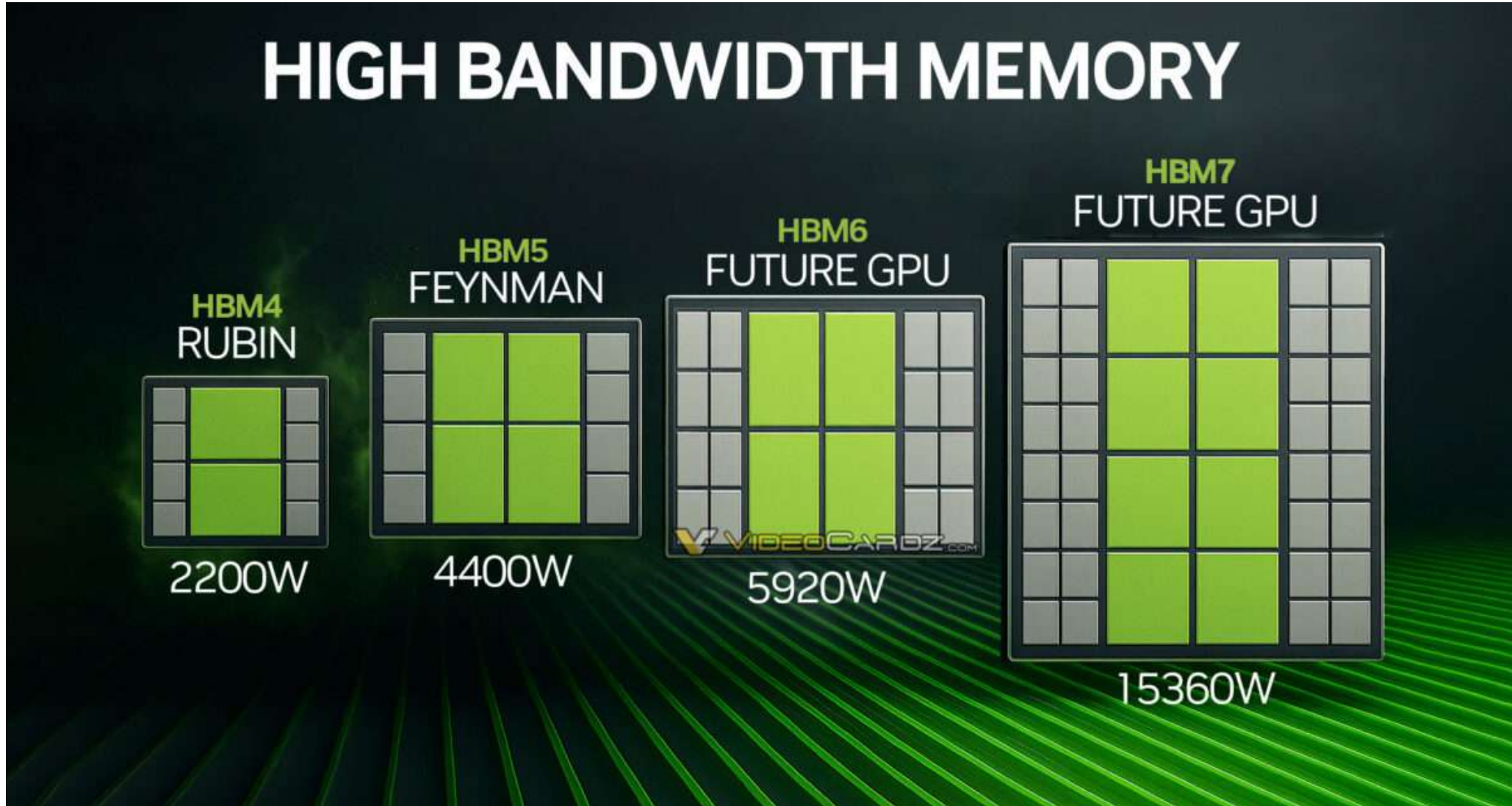


Solution: Several large chips
- Need fast communication
+ Possible to make fault-free
+ Possible to power and cool
+ Possible to package

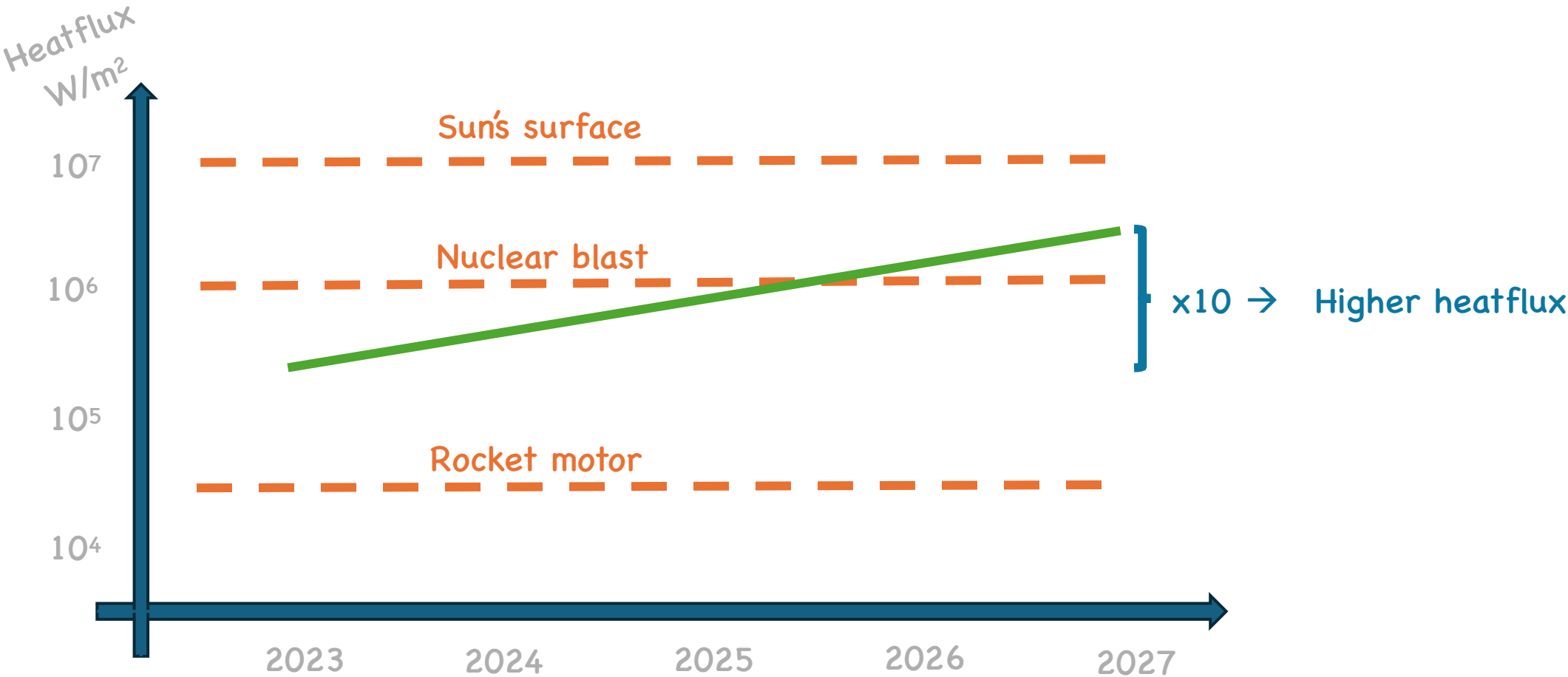
Development of number of Nvidia GPUs in one rack



Development of power for Nvidia GPUs

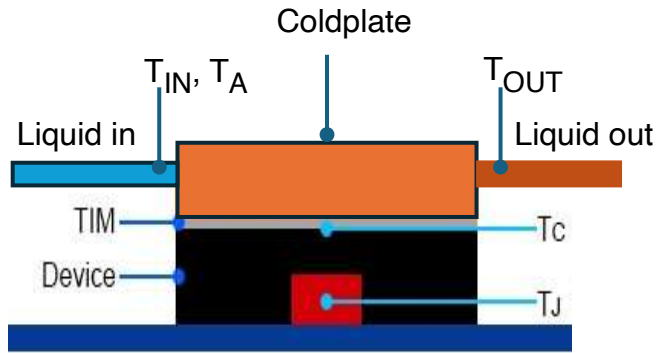


CPU/GPU heat flux (power per area)



Sources: Oktay, Sevgin, Robert Hannemann, and Avram Bar-Cohen. "High heat from a small package." Mech. Eng.:(United States) 108, no. 3 (1986).

Challenges with higher heatflux



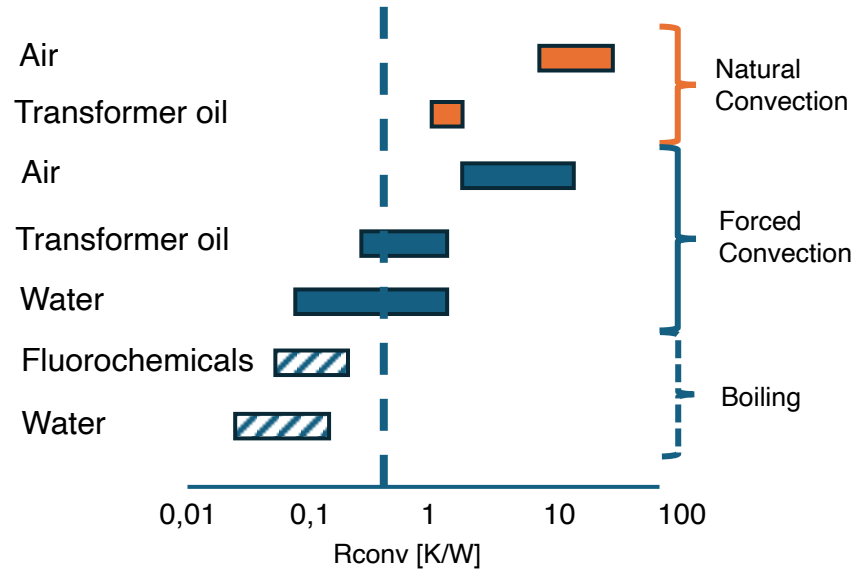
T_{IN}, T_A = Ambient temperature

T_C = Case temperature

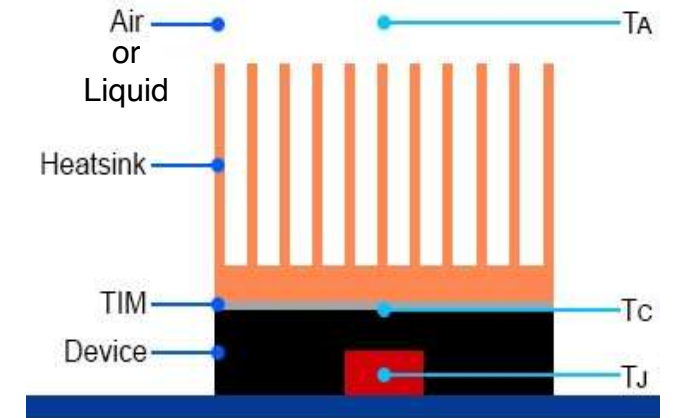
T_J = Junction temperature

TIM = Thermal Interface Material

On-chip



Server now



Immersion

Challenges with higher GPU density per rack

Power in 500kW–1MW at 800 VDC



Cool air in 60–120 cmm



Communication in & out



Future racks

Hot coolant out 1000–2000 lpm



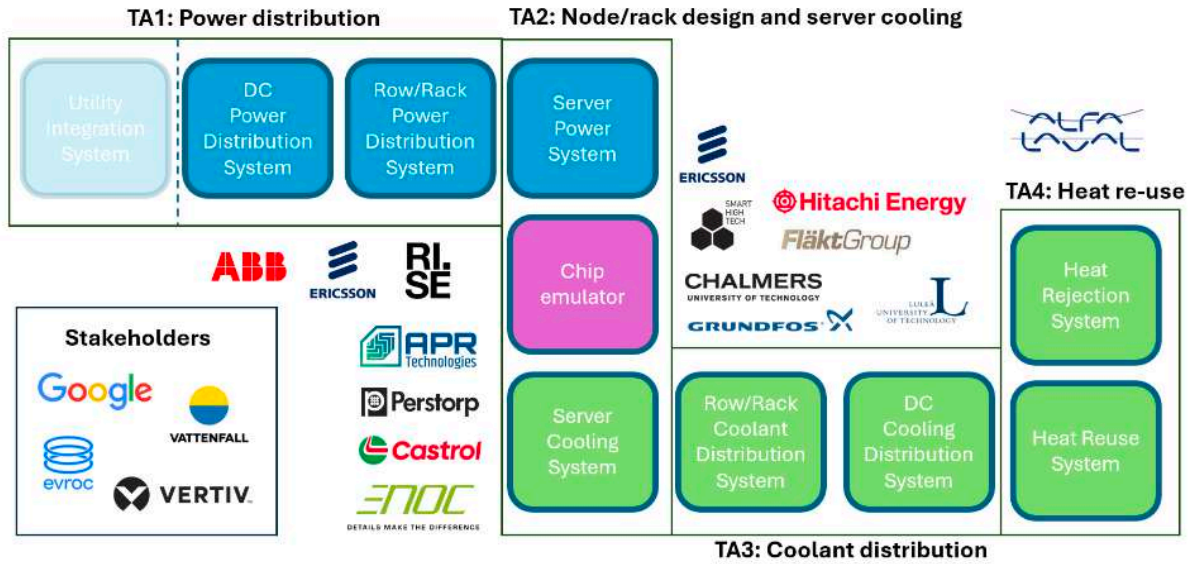
Warm air out 60–120 cmm



Lukewarm coolant in 1000–2000 lpm



Needed development in the industry



- **Power Distribution**

The entire power delivery chain—from high-voltage input to rack-level busbars—must be redesigned to minimize energy losses and maximize flexibility in handling dynamic loads.

- **Energy Storage**

Emerging technologies such as supercapacitors, hydrogen fuel systems, and advanced battery chemistries should be considered to manage power spikes, enhance sustainability, and support grid flexibility.

- **Power Electronics**

Efficient and reliable power conversion is essential from rack-level distribution down to the chip, requiring innovations in voltage regulation and energy management.

- **Coolant Distribution**

Liquid cooling systems must be optimized for low-loss thermal transport and balanced flow across the facility to ensure consistent and efficient heat removal.

- **Chip Heat Transfer**

Minimizing thermal resistance in the cooling loop—from the chip to the first heat exchanger—is critical. This includes optimizing thermal interface materials (TIM), cold plates, liquid flow, pumps, valves, and manifolds.

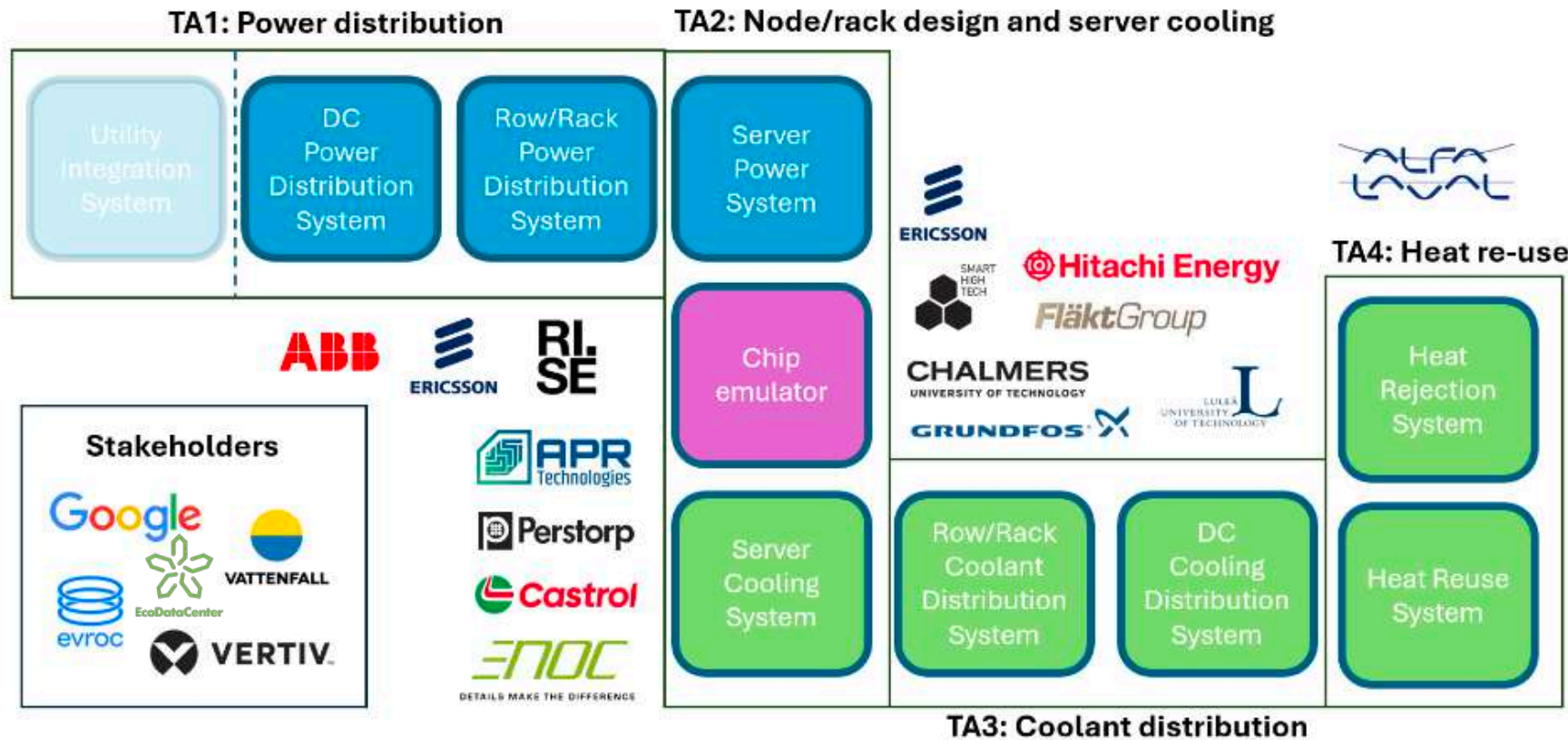
- **Hybrid Cooling Design**

Future racks will require hybrid cooling approaches, combining liquid cooling for high-performance GPUs with air cooling for supporting electronics to maintain overall system efficiency.

- **Heat Rejection**

Heat rejection systems must operate efficiently at the highest possible temperatures and adapt to diverse climate conditions to ensure sustainable thermal management.

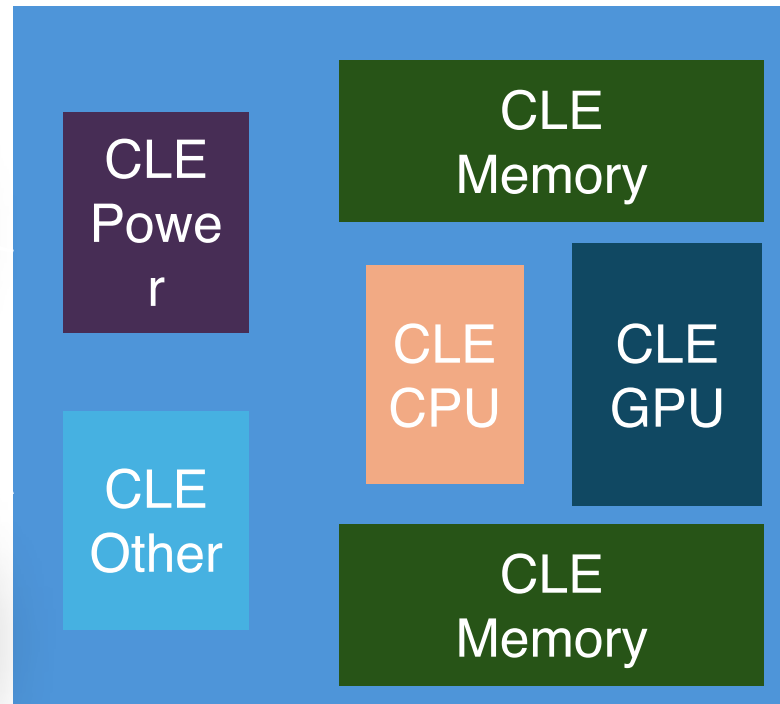
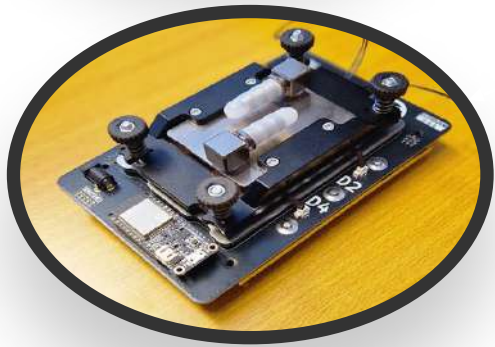
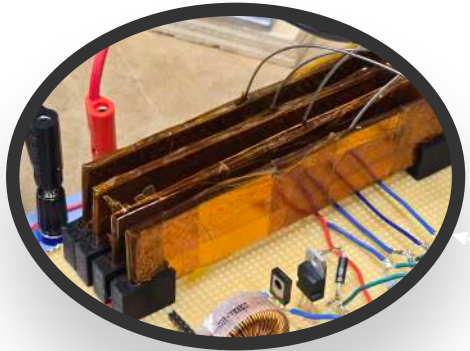
How the industry is coming together - The H-DINI project



Goals

- The project goal is to develop technologies and systems for power-dense AI compute with efficient power delivery and thermal performance.
- Demonstrate system solutions for selected technology areas
- Total budget €6M

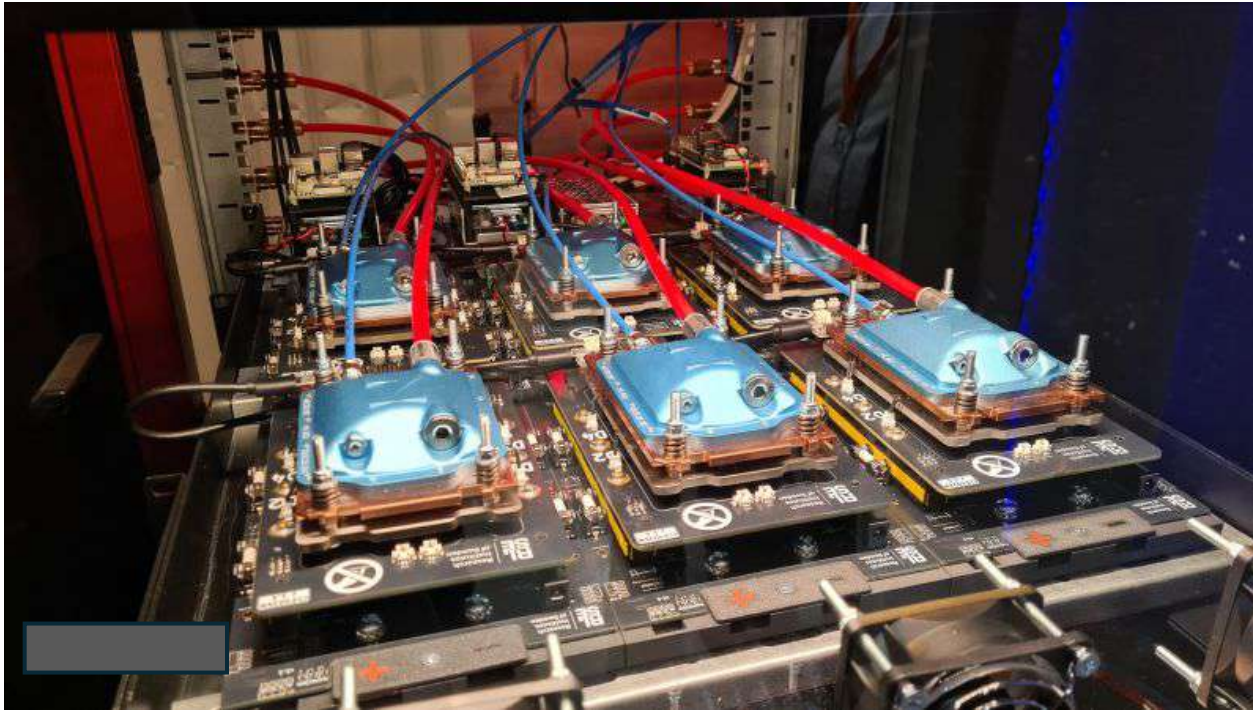
What if we can use a Server Emulator?



- Look like a server
- Accurately emulating real chip
- High Power Density
- Compatible with different cooling technologies
- Modular server design
- Can meet future standards

A server emulator consists of one or more CLE, Chip Load Emulators

RISE 2U Server Emulator single unit



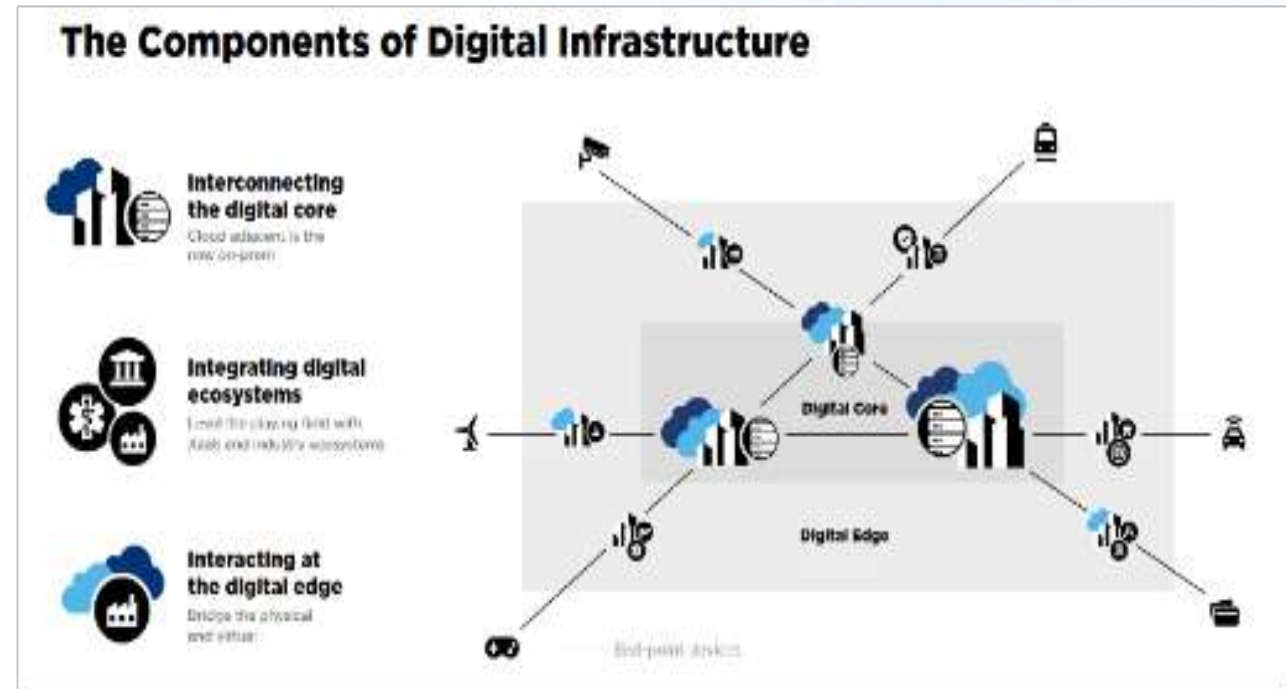
- Power (0-12000W)
- Temperature (0-100°C)
- Integrated control
- Monitoring of CLEs

EUDCA – ongoing
activities and the role
of the Nordics

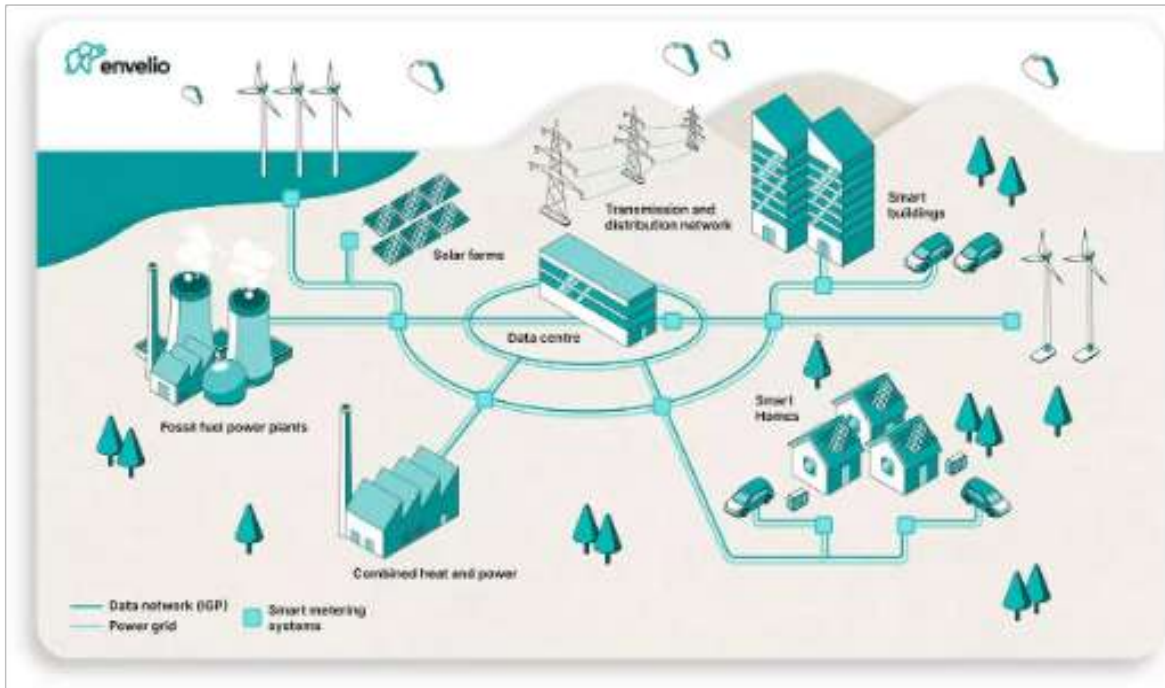
The Role of Data Centres in Europe's Digital Future

- ✓ **Invisible Backbone:** The essential foundation for AI, cloud computing, and digital services.
- ✓ **Global competitiveness:** Europe's success depends on secure, scalable infrastructure within its borders - goal of tripling the capacity.

Strategic Alignment: EUDCA is the voice of the industry to align growth with EU policy and energy goals.



Grid Integration & Energy Access – Collaboration on EU level



- ✓ **Key Collaboration:** Co-led by EUDCA and ENTSO-e EU Commission's Grid Integration Roundtable.
- ✓ **4 Working Groups:** Planning, Grid Rules, Queue Management, Flexibility.
- ✓ **Milestone:** Recommendations due Dec 2025.
- ✓ **Grid Partners:** Free up more capacity together, while keeping the electricity grid stable.

Policy Advocacy & Sovereignty

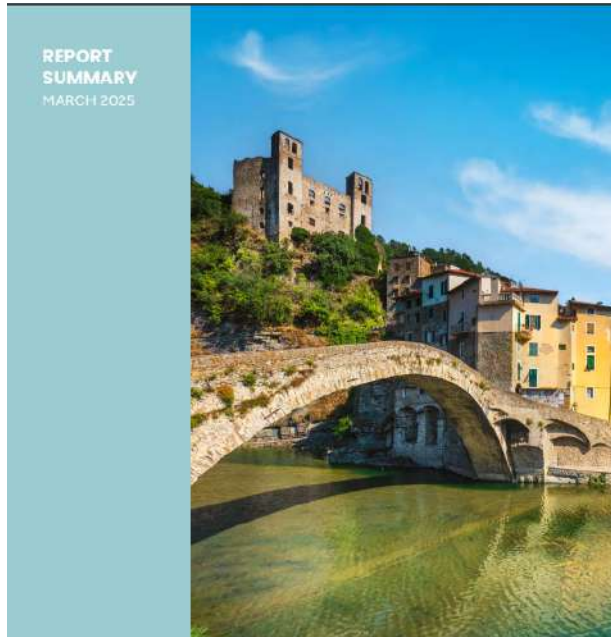
- ✓ **Capacity Growth:** Calling for tripling EU capacity to support AI & sovereignty.
- ✓ **Streamlining:** Advocating for faster permitting and grid modernization.
- ✓ **Open Approach:** Ensuring sovereignty through openness, not isolation.



EU Policy Landscape

Green Deal & EED	Digital Decade	Reforms	Resilience
Stricter sustainability and reporting requirements.	Tripling data centre capacity by 2030.	Energy market reforms and streamlined permitting.	CER & NIS2 regulations impacting operations.

Market Trends & Investment – EUDCA State of European Data Centres 2025



- ✓ **Demand Surge:** Driven by AI, cloud, edge, and digital transformation.
- ✓ **Growth:** €100B expected investment; 15% annual power demand growth.
- ✓ **New Hubs:** Tier-2 markets (Nordics, Spain, Poland) gaining traction.
- ✓ **Power is the biggest challenge:** 76% of the respondents mentioned Access to Power.

EU Engagement & Nordic Leadership

Shaping Policy

- ✓ Active in EED, AI Act, Data Act, and CER Directive.
- ✓ Harmonizing EU-wide Sustainability Label & Standards.
- ✓ Bringing the Nordic perspective to the “European table”.

Nordic Strengths

- ✓ Leadership in sustainability – e.g. renewables and heat reuse.
- ✓ Close collaboration cross-boarder for energy.
- ✓ Model for cross-border innovation and collaboration.



Nordic Opportunity

- ✓ **Digital Backbone:** The Nordics as Europe's sustainable hub for digital infrastructure.
- ✓ **Leadership:** Leading in energy, innovation, and cross-border collaboration.
- ✓ **Export:** Exporting best practices to shape the EU's digital future.



Building the Future Together

- ✓ Data centres are critical to Europe's digital ambitions.
- ✓ EUDCA is driving and influencing policies on a European level.
- ✓ The Nordics have a unique opportunity to lead by example.

"Let us together build a resilient, sovereign, and green digital future."